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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









STMUX1800L

16- to 8-bit MUX/DEMUX for gigabit Ethernet LAN switch with LED switch and enhanced ESD protection

Features

■ Low R_{ON}: 4.0 Ω typical

■ V_{CC} operating range: 3.0 to 3.6 V

■ Enhanced ESD protection: > 8 kV (contact) and 15 kV (HBM)

■ Channel on capacitance: 9.5 pF typical

■ Switching time speed: 9 ns

Near to zero propagation delay: 250 ps
 Very low crosstalk: -45 dB at 250 MHz

■ Bit-to-bit skew: 200 ps

> 600 MHz -3 dB typical bandwidth (or data frequency)

■ Three SPDT switches for LED support

 Rail-to-rail switching on data I/O ports (0 V to 5 V)

■ Package: QFN56

■ Pb-free

Applications

■ 10/100/1000 Mbit Ethernet switching

Audio/video switching



Description

The STMUX1800L is a 16- to 8-bit multiplexer/demultiplexer low R_{ON} bidirectional LAN switch designed for various standards, such as 10/100/1000 Ethernet. It is designed for very low crosstalk, low bit-to-bit skew and low I/O capacitance.

The differential signal from the Gigabit Ethernet transceiver is multiplexed into one of two selected outputs while the unselected switch goes to Hi-Z status.

The device integrates three SPDT (single pole dual throw) switches, for LED support.

Table 1. Device summary

Order code	Package	Packing
STMUX1800LQTR	QFN56	Tape and reel

Contents STMUX1800L

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STMUX1800L Pin description

1 Pin description

Figure 1. Pin connection (top through view)

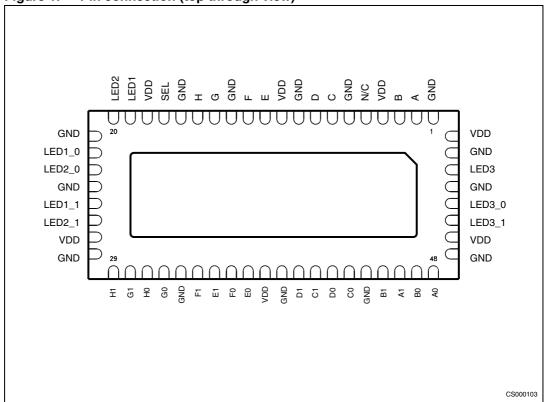


Table 2. Pin description

Pin	Symbol	Name and function
2, 3, 7, 8, 11, 12, 14, 15	A, B, C, D, E, F, G, H	8-bit bus
48, 47, 43, 42, 37, 36, 32, 31	A0, B0, C0, D0, E0, F0, G0, H0	8-bit multiplexed to bus 0
46, 45, 41, 40, 35, 34, 30, 29	A1, B1, C1, D1, E1, F1, G1, H1	8-bit multiplexed to bus 1
5	N/C	Not connected
17	SEL	Bus and LED switch selection
19, 20, 54	LED1, LED2, LED3	LED switch input
22, 23, 25, 26, 51, 52	LED1_0, LED2_0, LED1_1, LED2_1, LED3_1, LED3_0	LED switch output
4, 10, 18, 27, 38, 50, 56	V _{DD}	Supply voltage
1, 6, 9, 13, 16, 21, 24, 28, 33, 39, 44, 49, 53, 55	GND	Ground

Pin description STMUX1800L

Figure 2. Input equivalent circuit

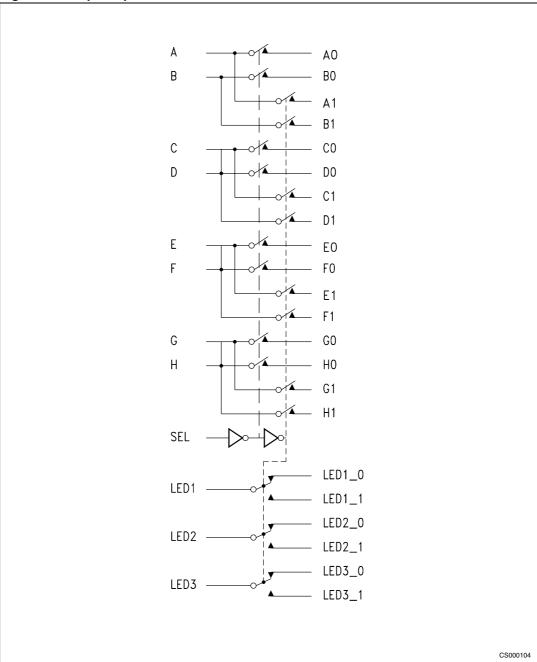


Table 3. LAN switch function table

SEL	Function
L	8-bit bus to 8-bit multiplexed bus 0
Н	8-bit bus to 8-bit multiplexed bus 1

STMUX1800L Pin description

Table 4. LED switch function table

SEL	Function
L	LED switch input connected to LED switch output X_0
Н	LED switch input connected to LED switch output X_1

Maximum ratings STMUX1800L

2 Maximum ratings

Stressing the device above the rating listed in the "absolute maximum ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 5. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage to ground	-0.5 to 4.6	V
V _{IO}	DC input output voltage	-0.5 to 4.6	٧
V _{IC}	DC control input voltage	-0.5 to 4.6	V
I _O	DC output current ⁽¹⁾	120	mA
P _D	Power dissipation	0.5	W
T _{stg}	Storage temperature	-65 to 150	°C
T _L	Lead temperature (10 sec)	300	°C

^{1.} If V_{IO} x I_O does not exceed the maximum limit of P_D.

2.1 Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter		Unit		
		Min	Тур	Max	Oille
V _{CC}	Supply voltage to ground	3	_	3.6	V
V _{IC}	DC control input voltage (SEL)	0	_	5	V
V _{IO}	DC input/output voltage	0	_	V _{CC}	V
T _A	Operating temperature	-40	1	85	°C

3 Electrical characteristics

Table 7. DC electrical characteristics for Gigabit Ethernet LAN8/16MUX/DEMUX $(V_{CC} = 3.3 \text{ V} \pm 10\%)$

	Parameter	Test condition		Value		
Symbol			-40 to 85 °C			Unit
			Min	Тур	Max	
V _{IH}	Voltage input high (SEL)	High level guaranteed	2	_	_	V
V _{IL}	Voltage input low (SEL)	Low level guaranteed	-0.5	-	0.8	V
V_{IK}	Clamp diode voltage (SEL)	$V_{CC} = 3.6 \text{ V}$ $I_{IN} = -18 \text{ mA}$	_	-0.8	-1.2	V
I _{IH}	Input high current (SEL)	$V_{CC} = 3.6 \text{ V}$ $V_{IN} = V_{CC}$	_	-	±5	μΑ
I _{IL}	Input low current (SEL)	$V_{CC} = 3.6 \text{ V}$ $V_{IN} = \text{GND}$	_	_	±5	μΑ
IOFF _(SW) ⁽¹⁾	Leakage current through the switch common terminals (A to H) (LED1 to LED3)	$V_{CC} = 3.6 \text{ V}$ A to H = V_{CC} LED1 to LED3 = V_{CC} A0 to H0 = 0 V A1 to H1 = floating LEDx_0 = 0 V LEDx1 = floating SEL = V_{CC}	-	_	±1	μΑ
IOFF _(SEL)	SEL pin leakage current	V _{CC} = 0 V SEL = 0 to 3.6 V	_	_	±1	μΑ
R _{ON}	Switch ON resistance ⁽²⁾	V_{CC} = 3.0 V V_{IN} = 1.5 to V_{CC} I_{IN} = -40 mA	_	4.0	6.5	Ω
R _{FLAT}	ON resistance flatness (2)	$V_{CC} = 3.0 \text{ V}$ V_{IN} at 1.5 and VCC $I_{IN} = -40 \text{ mA}$	_	0.5	_	Ω
ΔR_{ON}	ON resistance match between channel $ \Delta R_{ON} = R_{ONMAX} - R_{ONMIN} $	$V_{CC} = 3.0 \text{ V}$ $V_{IN} = 1.5 \text{ to } V_{CC}$ $I_{IN} = -40 \text{ mA}$	_	0.4	1	Ω

^{1.} Refer to Figure 4: Test circuit for leakage current (IOFF) on page 11

^{2.} Measured by voltage drop between channels at indicated current through the switch. ON resistance is determined by the lower of the voltages.

^{3.} Flatness is defined as the difference between the R_{ONMAX} and R_{ONMIN} of ON resistance over the specified range.

^{4.} ΔR_{ON} measured at same $V_{CC},$ temperature and voltage level.

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Table 8. DC electrical characteristics for 10/100 Ethernet LAN8/16MUX/DEMUX ($V_{CC} = 3.3 \text{ V} \pm 10$)

	(100 - 0.0 1 - 1.0)	Test condition		Value		
Symbol	Parameter		-40 to 85 °C			Unit
			Min	Тур	Max	
V _{IH}	Voltage input high (SEL)	High level guaranteed	2	-	-	V
V_{IL}	Voltage input low (SEL)	Low level guaranteed	-0.5	I	0.8	V
V_{IK}	Clamp diode voltage (SEL)	$V_{CC} = 3.6 \text{ V}$ $I_{IN} = -18 \text{ mA}$	_	-0.7	-1.2	V
I _{IH}	Input high current (SEL)	$V_{CC} = 3.6 \text{ V}$ $V_{IN} = V_{CC}$	_	-	±5	μΑ
I _{IL}	Input low current (SEL)	$V_{CC} = 3.6 \text{ V}$ $V_{IN} = \text{GND}$	_	-	±5	μΑ
IOFF _(SW) ⁽¹⁾	Leakage current through the switch common terminals (A to H) (LED1 to LED3)	$V_{CC} = 3.6 \text{ V}$ A to H = V_{CC} LED1 to LED3 = V_{CC} A0 to H0 = 0 V A1 to H1 = floating LEDx_0 = 0 V LEDx1 = floating SEL = V_{CC}	-	ı	±1	μА
IOFF _(SEL)	SEL pin leakage current	V _{CC} = 0 V SEL = 0 to 3.6 V	_	-	±1	μΑ
R _{ON}	Switch ON resistance ⁽²⁾	$V_{CC} = 3.0 \text{ V}$ $V_{IN} = 1.5 \text{ to } V_{CC}$ $I_{IN} = -10 \text{ to } -30 \text{ mA}$	_	4.0	6.5	Ω
R _{FLAT}	ON resistance flatness (2) (3)	V_{CC} = 3.0 V V_{IN} at 1.5 and V_{CC} I_{IN} = -10 to -30 mA	_	0.5	_	Ω
ΔR_{ON}	ON resistance match between channel $ \Delta R_{ON} = R_{ONMAX} - R_{ONMIN}^{(2)(4)} $	$V_{CC} = 3.0 \text{ V}$ $V_{IN} = 1.5 \text{ to } V_{CC}$ $I_{IN} = -10 \text{ to } -30 \text{ mA}$	-	0.4	1	Ω

^{1.} Refer to Figure 4: Test circuit for leakage current (IOFF) on page 11

Measured by voltage drop between channels at indicated current through the switch. ON resistance is determinate by the lower of the two voltages.

^{3.} Flatness is defined as the difference between the R_{ONMAX} and R_{ONMIN} of ON resistance over the specified range.

^{4.} ΔR_{ON} measured at same $V_{CC},$ temperature and voltage level.

Table 9.	Capacitance ($(T_{\Delta} = 25 ^{\circ}C, f = 1 MHz)$
iabic J.	Oapacitarioc ($(1\Delta - 23 \ O, 1 - 1 \ William)$

Cumbal	Parameter	Test condition	Value			Unit
Symbol			Min	Тур	Max	Oliit
C _{IN}	SEL pin input capacitance ⁽¹⁾	DC = 0.25 V AC = 0.5 V _{PP} f = 1 MHz	-	2	3	pF
C _{OFF}	Switch off capacitance ⁽²⁾	DC = 0.25 V AC = 0.5 V _{PP} f = 1 MHz	-	4	5	pF
C _{ON}	Switch on capacitance ⁽³⁾	DC = 0.25 V AC = 0.5 V _{PP} f = 1 MHz	-	9.5	11	pF

- 1. Refer to Figure 5 on page 12
- 2. Refer to Figure 6 on page 12
- 3. Refer to Figure 7 on page 13

Table 10. Power supply characteristics

		Test condition		Unit		
Symbol	Parameter		-40 to 85 °C			
			Min	Тур	Max	
I _{CC}	Quiescent power supply	$V_{CC} = 3.6 \text{ V}, V_{IN} = V_{CC} \text{ or }$ GND	-	150	500	μA

Table 11. Dynamic electrical characteristics ($V_{CC} = 3.3 \text{ V} \pm 10\%$)

			Value			
Symbol	Parameter	Test condition	-	40 to 85 °C		Unit
			Min	Тур	Max	
X _{talk}	Crosstalk ⁽¹⁾	R_L = 100 Ω f = 250 MHz	-	-45	-	dB
O _{IRR}	Off isolation ⁽²⁾	R_L = 100 Ω f = 250 MHz	-	-37	ı	dB
BW	-3 dB bandwidth ⁽³⁾	$R_L = 100 \Omega$ 0 < $V_{IN} \le 3.6 V$	1	600	ı	MHz

- 1. Refer to Figure 9 on page 14
- 2. Refer to Figure 10 on page 15
- 3. Refer to Figure 8 on page 13

Electrical characteristics STMUX1800L

Table 12. Switching characteristics ($T_A = 25$ °C, $V_{CC} = 3.3$ V ±10%)

Cumhal	Parameter	Test condition	Value			11
Symbol			Min	Тур	Max	Unit
t _{PD}	Propagation delay	V _{CC} = 3 to 3.6 V	-	0.25	1	ns
t _{PZH} , t _{PZL}	Line enable time, SE to x to x0 or x to x1	V _{CC} = 3 to 3.6 V	0.5	6.5	15	ns
t _{PHZ} , t _{PLZ}	Line disable time, SE to x to x0 or x to x1	V _{CC} = 3 to 3.6 V	0.5	6.5	8.5	ns
t _{SK(O)}	Output skew between center port to any other port	V _{CC} = 3 to 3.6 V	-	0.1	0.2	ns
t _{SK(P)}	Skew between opposite transition of the same output (tphl, tplh)	V _{CC} = 3 to 3.6 V	-	0.1	0.2	ns

Table 13. ESD performance

Symbol	Test condition	Value			Unit
		Min	Тур	Max	Offic
ESD	Contact discharge ⁽¹⁾ IEC61000-4-2	-	±8	-	kV
	Human body model (MIL-STD-883)	_	±15	_	kV

^{1.} Refer to Figure 3: Diagram for suggested VDD decoupling on page 11.

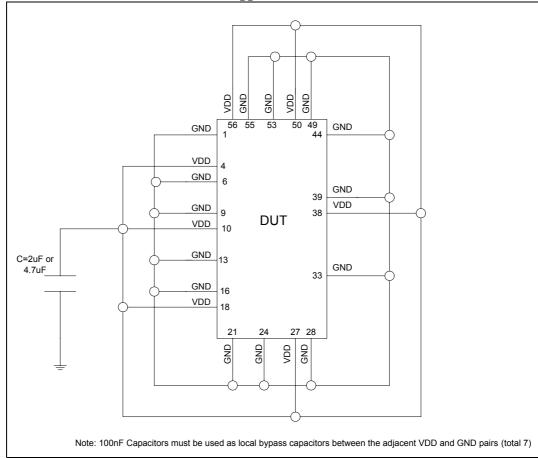
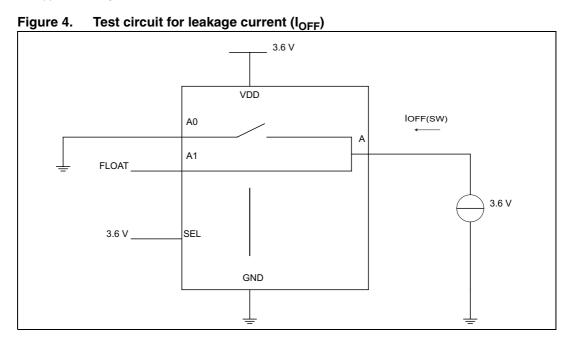


Figure 3. Diagram for suggested V_{DD} decoupling

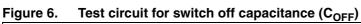
1. Applicable for system level ESD test

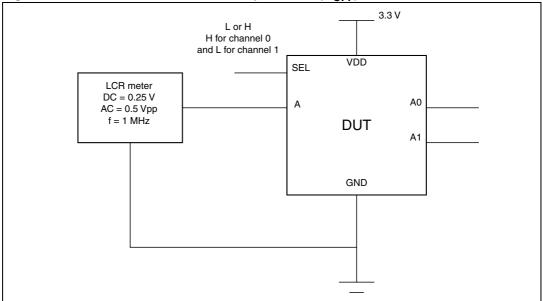


STMUX1800L **Electrical characteristics**

3.3 V VDD LCR meter DC = 0.25 V SEL AC = 0.5 Vppf = 1 MHz DUT GND

Test circuit for SEL pin input capacitance (C_{IN}) Figure 5.





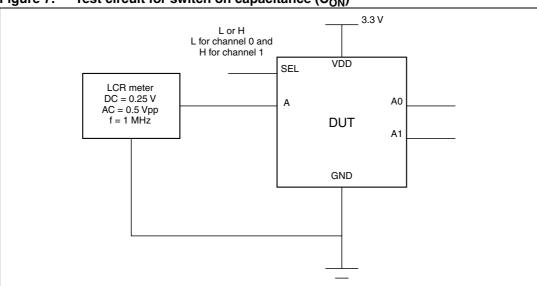
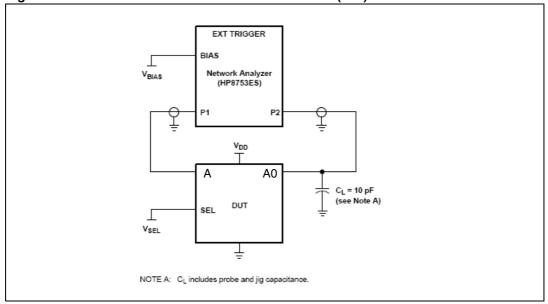


Figure 7. Test circuit for switch on capacitance (C_{ON})

Figure 8. Test circuit for bandwidth measurement (BW)



Frequency response is measured at the output of the ON channel. For example, when $V_{SEL} = 0$ and A is the input, the output is measured at A0. All unused analog I/O ports are left open.

HP8753ES setup:

Average = 4

 $R_{BW} = 3 \text{ kHz}$

 $V_{BIAS} = 0.35 V$

ST = 2 s

P1 = 0 dBm

Electrical characteristics STMUX1800L

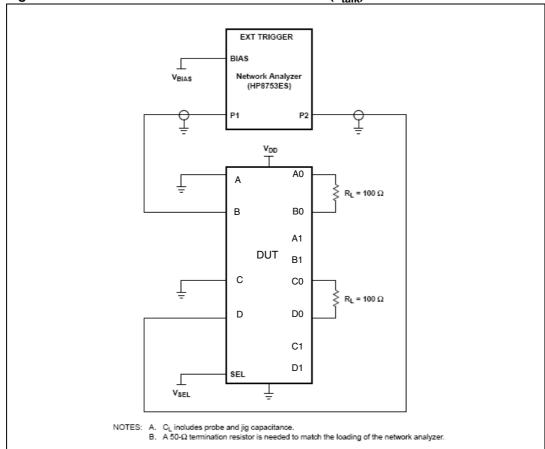


Figure 9. Test circuit for crosstalk measurement (x_{talk})

Crosstalk is measured at the output of the non-adjacent ON channel. For example, when $V_{SEL} = 0$, and B is the input, the output is measured at D. All unused analog input ports are connected to GND and output ports are left open.

HP8753ES setup:

Average = 4

 $R_{BW} = 3 \text{ kHz}$

 $V_{BIAS} = 0.35 V$

ST = 2 s

P1 = 0 dBm

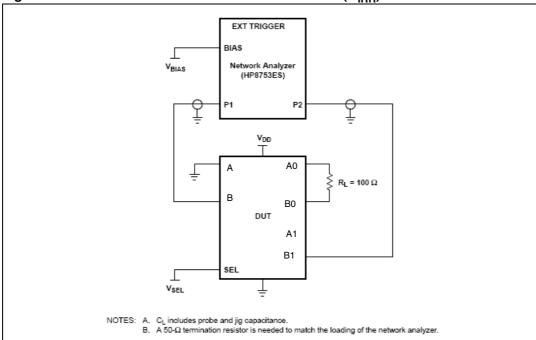


Figure 10. Test circuit for off isolation measurement (OIRR)

Off isolation is measured at the output of the OFF channel. For example, when V_{SEL} =0, and B is the input, the output is measured at B1. All unused analog input ports are connected to GND and output ports are left open.

HP8753ES setup:

Average = 4

 $R_{BW} = 3 \text{ kHz}$

 $V_{BIAS} = 0.35 V$

ST = 2 s

P1 = 0 dBm

Package mechanical data 4

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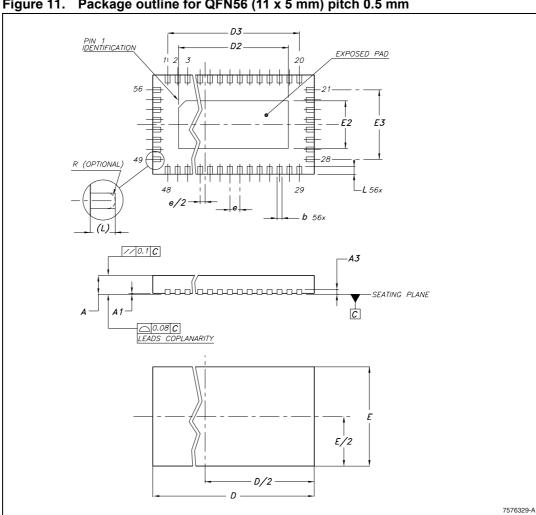
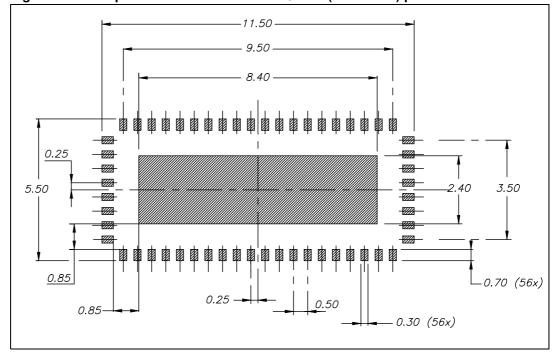


Figure 11. Package outline for QFN56 (11 x 5 mm) pitch 0.5 mm

Figure 12. Mechanical data for QFN56 (11 x 5 mm) pitch 0.5 mm

Cumbal	Millimeters				
Symbol	Min	Тур	Max		
А	0.70	0.75	0.80		
A1	_	_	0.05		
A3		0.20	_		
b	0.20	0.25	0.30		
D	10.90	11.00	11.10		
D2	8.30	8.40	8.50		
D3	_	9.50	-		
E	4.90	5.00	5.10		
E2	2.30	2.40	2.50		
E3	_	3.50	-		
е	-	0.50	-		
L	0.30	0.40	0.50		

Figure 13. Footprint recommendation for QFN56 (11 x 5 mm) pitch 0.5 mm



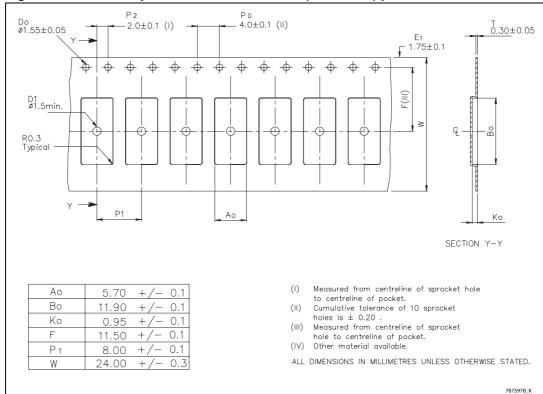


Figure 14. Carrier tape information for QFN56 (11 x 5 mm) pitch 0.5 mm

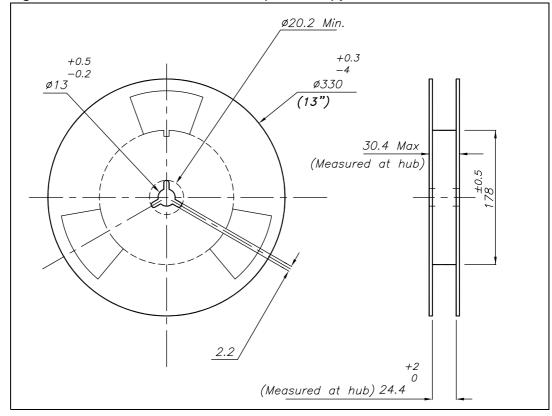


Figure 15. Reel information for QFN56 (11 x 5 mm) pitch 0.5 mm

Revision history STMUX1800L

5 Revision history

Table 14. Document revision history

Date	Revision	Changes
26-Feb-2008	1	Initial release.
24-Sep-2008	2	Modified: datasheet title, channel on capacitance value from 7.5 pF to 9.5 pF typical, <i>Figure 1, Table 2, Section 3: Electrical characteristics.</i> Added: fields of applications, <i>Table 6</i> and QFN56 footprint recommendations in <i>Figure 13 on page 17</i> .
30-Mar-2009	3	Updated: Features section, <i>Table 5 on page 6, Table 11 on page 9</i> and <i>Table 13 on page 10</i> and <i>Chapter 4: Package mechanical data.</i>
22-Jun-2009	4	Document promoted from Preliminary data to datasheet.

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